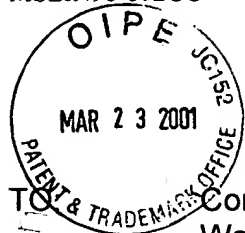


MSLIN98-002CC

Application no. 09/251,183



March 20, 2001

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Krusa
3-24-01

TO: Commissioner of Patents and Trademarks
Washington, D.C. 20231

FROM: George O. Saile, Reg. No. 19,572
20 McIntosh Drive
Poughkeepsie, N.Y. 12603

SUBJECT: Serial #: 09/251,183
File Date: 2/17/99
Inventor: Lin, M.S.
Examiner: J. Garcia
Art Unit: 2823
Title: Top Layers of Metal for High Performance IC's

03/29/2001 TDAWKINS 00000003 190033 09251183 RESPONSE TO OFFICE ACTION
01 FC:102 160.00 CH

This is in response to the office action dated Oct. 20, 2000. Please amend the
above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States
Postal Service as first class mail in an envelope addressed to: Commissioner of
Patents and Trademarks, Washington, D.C. 20231 on March 20, 2001.

Signature Stephen B. Ackerman
Stephen B. Ackerman, Reg. No. 37,761

Date: 3/20/01